506525626 02/25/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6572402

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MARK LEWIS	02/22/2021

RECEIVING PARTY DATA

Name:	SUSTAINABLE FIBER TECHNOLOGIES, LLC
Street Address:	234 SW 43RD ST.
Internal Address:	SUITE MB
City:	RENTON
State/Country:	WASHINGTON
Postal Code:	98057

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16142683

CORRESPONDENCE DATA

Fax Number: (330)434-8888

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 3304349999

Email: IPLAW@ETBLAW.COM

Correspondent Name: EMERSON THOMSON & BENNETT, LLC

Address Line 1: 1914 AKRON-PENINSULA ROAD

Address Line 4: AKRON, OHIO 44313

ATTORNEY DOCKET NUMBER:	41442.50016
NAME OF SUBMITTER:	PETER DETORRE
SIGNATURE:	/Peter Detorre/
DATE SIGNED:	02/25/2021

Total Attachments: 2

source=20210225_Assignment_41442_50016#page1.tif source=20210225_Assignment_41442_50016#page2.tif

PATENT 506525626 REEL: 055418 FRAME: 0110

Docket No.: 41442.50016

Application No.: 16/142,683

Filing Date: September 26, 2018

ASSIGNMENT

This Assignment is made by Mark Lewis of 19229 99th Pl. S. Renton, WA 98055, (the Inventor), to Sustainable Fiber Technologies, LLC, a Washington corporation, having its principal place of business at 234 SW 43rd St. Suite MB Renton, WA 98057 (the Assignee). Inventor believes that he/she is the original inventor of Aqueous Lignin and Hemicellulose Dispersion (the Invention), which is at least partially described in the abovenumbered patent application filed on the above-indicated date (the Application). Inventorrepresents and warrants that he/she is the owner of the right, title, and interest in and to the Invention and the Application as inventor, having full right and power to convey his/her entire interest, both legal and equitable, in this Assignment. Inventor further represents and warrants that the rights transferred in this Assignment are free of lien, encumbrance, or adverse claim.

For valuable consideration, receipt and sufficiency of which are hereby acknowledged, Inventor and Assignee agree as follows:

- 1. Inventor does hereby sell, assign, convey, and transfer to Assignee, its successors, assigns, nominees, or other legal representatives the full, exclusive, entire, worldwide rights, title, and interest in, to and under said Invention as described and claimed in any form or embodiment thereof, and in and to the Application including in and to any application filed in this or any foreign country based thereon, including the right to file said foreign applications under the provisions of any international convention; also his/her entire right, title, and interest in and to any and all patents or reissues or extensions thereof to be obtained in this or any foreign country upon the Invention and any divisional, continuation, continuation-in-part, or substitute applications which may be filed upon the Invention in this or any foreign country; and in and to all income, royalties, damages, claims, and payments now or hereafter due or payable with respect thereto; and in and to all causes of action, either in law or in equity, for past, present, or future infringement based on the Invention; and Inventor hereby authorizes and requests the issuing authority to issue any and all patents on the Invention to said Assignee or its successors and assigns.
- 2. Inventor further agrees to execute all divisional, continuing, substitute, improvement, extension, reissue, and other patent applications in this or any foreign country relating to the Invention or the Application and to sign all other lawful papers and to perform all other lawful acts without further consideration, but without expense to Inventor, which Assignee may deem necessary or desirable to make this Assignment fully effective, including, by way of example but not of limitation, the following acts:
 - a. prompt execution of all lawful oaths, affidavits, and/or supplemental oaths required or deemed advisable by Assignee to further the prosecution of any application or applications for patents relating to the Invention; and
 - b. co-operation to the best of Inventor's ability in the execution of all lawful documents, the production of evidence, and the giving of testimony in interference, opposition, derivation, review, nullification, examination, re-examination, infringement, or other proceedings involving the Invention, the Application, or any other applications or patents upon the Invention or the Application.
- 3. The Application was made or was authorized to be made by Inventor.

Inventor, intending to be legally bound, has signed this Assignment on the date written by the Inventor's signature below. Inventor hereby acknowledges that any willful false statement made in this Assignment is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

JUDITH M PILCHER Notary Public State of Washington Commission # 105211 My Comm. Expires Aug 9, 2024	Mark Lewis	, <u>Z-2Z-Z/</u> 202∳ Date
State of Wa)	
County of Columbia.	}	
On this 22 day of the personally known, and known to me to be me the signing of samg as his free act as	be the person who signed the foregoing	me personally appeared Mark Lewis, assignment, and acknowledged before
- Jusith Mtileher	Just Mus	lin ,8/9/ ,20H
Notary Public (Print Name)	Signature	Date Commission Expires

RECORDED: 02/25/2021